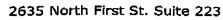
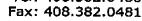
patent law group LLP





San Jose, CA 95134 Tel: 408.382.0480



FACSIMILE COVER SHEET

Date:	January 6, 2006	Fax:	571-273-8300
To:	U.S. Patent and Trademark Office	Phone:	

Commissioner for Patents P. O. Box 1450

4083820481

Alexandria, VA 22313-1450

From:	David C. Hsia
Serial No.:	10/826,800
Docket:	10030280-4
Re:	Restriction Requirement
Pages:	6 (including cover sheet)

Message:

Re:

Applicant(s):

Tanya J. Snyder, Robert H. Yi, Robert E. Wilson

Assignee:

Agilent Technologies, Inc.

Title:

Wafer Bonding Using Reactive Foils for Massively Parallel

Micro-Electromechanical Systems Packaging

Serial No.:

10/826,800

Examiner:

David Nhu

Filed: April 15, 2004 Group Art Unit: 2818

Docket No.:

10030280-4

Dear Sir:

Transmitted herewith are the following documents in the above-identified application:

(1) Transmittal Letter (1 page);

(2) Response to Office Action (4 pages).

The information contained in this message is intended only for the personal and confidential use of the designated recipient(s) named above. This message may be an attorney-client communication and may be protected by the work product doctrine. As such, this document is privileged and confidential. If the reader of this message is not the intended recipient, you are hereby notified that you have received this document in error and that any review, dissemination, distribution, or copying of this message is strictly prohibited. If you have received this communication in error, please notify us immediately by telephone and destroy any copies of this document in your possession. Thank you.

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AVAGO TECHNOLOGIES, LTD. P.O. Box 1920 Denver, Colorado 80201-1920

JAN 0 6 2006

ATTORNEY DOCKET NO. 10030280-4

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventor(s): Tanya J. Snyder et al.

Serial No.: 10/826,800

Filing Date: April 15, 2004

Examiner: David Nhu

Group Art Unit: 2818

Title: WAFER BONDING USING REACTIVE FOILS FOR MASSIVELY PARALLEL

MICRO-ELECTROMECHANICAL SYSTEMS PACKAGING

COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria VA 22313-1450

Sir	TRANSMITTAL LETTER FOR RESPONSE/AMENDMENT											
Tra	ansmitted he	rewith Is/are the folio	wing in the	e above-identifie	i applicati	ion:						
K		:/Amendment	Petition to extend time to respond									
	New fee as calculated below			Supplemental Declaration								
K	<u> </u>											
	Other: (Fee \$)											
	CLAIMS AS AMENDED BY OTHER THAN A SMALL ENTITY											
	(1) FOR	(1) (2)		(4) HIGHEST NUMBER PREVIOUSLY PAID FOR		(5) PRESENT EXTRA	(6) RATE	(7) ADDITIONAL FEES				
L	TOTAL GLAIMS	6	MINUS	20		0	X 50	\$	0			
	INDEP. CLAIMS	2	MINUS	3	F	0	X 200	\$	0			
	FIRST PRESENTATION OF A MULTIPLE DEPENDENT CLAIM						+ 360	\$	0			
	EXTENSION FEE	1 ^{8T} MONTH 120.00	2 ND MONT 450.00	TH 3 RD MC 1020.		4 th MC 1590.0		\$	0			
						OTH	FR FFFS	3	n			

Charge \$ 0 to Deposit Account 50-3718. At any time during the pendency of this application, please charge any fees required or credit any over payment to Deposit Account 50-3718 pursuant to 37 CFR 1.2 5. Additionally please charge any fees to Deposit Account 50-3718 under 37 CFR 1.16, 1.17, 1.19, 1.20 and 1.21. A duplicate copy of this transmittal letter is enclosed.

I hereby certify that this paper is being facsimile transmitted to the Patent and Trademark Office on the date shown below:

Date of facsimile: January 6, 2006

Typed Name: David C Hsja

Signature:

Respectfully submitted,

Tanya J. Snyder et al.

TOTAL ADDITIONAL FEE FOR THIS AMENDMENT | \$

David C. Hsia

Attorney/Agent for Applicant(s)

Reg. No. 46,235

Date: January 6, 2006

Telephone No. (408) 382-0480

Rev 10/04 (TransAma)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s):

Tanya J. Snyder, Robert H. Yi, Robert E. Wilson

Assignee:

Agilent Technologies, Inc.

Title:

Wafer Bonding Using Reactive Foils for Massively Parallel Micro-

Electromechanical Systems Packaging

Serial No.:

10/826,800

4083820481

Filing Date:

April 15, 2004

Examiner:

David Nhu

Group Art Unit: 2818

Docket No.:

10030280-4

San Jose, California January 6, 2006

Mail Stop Amendment Commissioner for Patents P. O. Box 1450 Alexandria, VA 22313-1450

RESPONSE TO OFFICE ACTION

Dear Sir:

In response to the December 8, 2005 Office Action, please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing of claims which beings on page 2 of this paper.

Remarks begin on page 4 of this paper.